

Texas Instruments Enhanced Plastic Packages Moisture Sensitivity Classification

Moisture sensitivity classifications contained within this document are current at the document publish date. The moisture sensitivity level on the device shipping box label will take precedence over information in this document.

Mixed Signal and Analog Enhanced Plastic Moisture Sensitivity Level				
Device	Level 1	Level 2	Level 3	Level 4
LM211QDREP	220°C			
PCI1520IGHKEP			220°C	
SN65LBC176AQDREP	220°C			
THS1401QPHPEP			220°C	
THS1403QPHPEP			220°C	
THS1408MPHPEP			220°C	
TL16C752BTPTREP		220°C		
TLC1543QDWREP	220°C			
TLC2272AMDREP	220°C			
TLC2543QDWREP	220°C			
TLC3702MDREP	220°C			
TLV2462AQDREP	220°C			
TLV2463AQDREP	220°C			
TLV5619QDWREP	220°C			
TLV5638QDREP	220°C			
TPS3307-18MDREP	220°C			
TPS75201QPWPREP	220°C			
TPS75215QPWPREP	220°C			
TPS75218QPWPREP	220°C			
TPS75225QPWPREP	220°C			
TPS75233QPWPREP	220°C			
TPS75301QPWPREP	220°C			
TPS75315QPWPREP	220°C			
TPS75318QPWPREP	220°C			
TPS75325QPWPREP	220°C			
TPS75333QPWPREP	220°C			
TPS76701QPWPREP	220°C			
TPS76715QPWPREP	220°C			
TPS76718QPWPREP	220°C			
TPS76725QPWPREP	220°C			
TPS76733QPWPREP	220°C			
TPS76750QPWPREP	220°C			
TPS76801QPWPREP	220°C			
TPS76815QPWPREP	220°C			
TPS76818QPWPREP	220°C			
TPS76825QPWPREP	220°C			
TPS76833QPWPREP	220°C			
TPS76850QPWPREP	220°C			
TPS77501MPWPREP	220°C			
TPS77515MPWPREP	220°C			
TPS77518MPWPREP	220°C			
TPS77525MPWPREP	220°C			
TPS77533MPWPREP	220°C			
TPS77601QPWPREP	220°C			
TPS77615QPWPREP	220°C			
TPS77618QPWPREP	220°C			
TPS77625QPWPREP	220°C			
Device	Level 1	Level 2	Level 3	Level 4

Logic Enhanced Plastic Moisture Sensitivity Level				
Device	Level 1	Level 2	Level 3	Level 4
CD74HC10MM96EP	235°C	250°C		
CD74HC153MM96EP	235°C	250°C		
CD74HC20MM96EP	235°C	250°C		
CD74HC4051MM96EP	220°C			
CD74HC4538MM96EP	235°C	250°C		
SN74ABTH32245MPZEP		220°C		
SN74ABTH32543MPZEP		220°C		
SN74ACT16245QDLREP	235°C			
SN74ACT16373QDLREP	235°C			
SN74ACT16374QDLREP	235°C			
SN74AHC00MDREP	220°C			
SN74AHC02MPWREP	250°C			
SN74AHC04MDREP	235°C	250°C		
SN74AHC04MPWREP	250°C			
SN74AHC08MDREP	235°C	250°C		
SN74AHC08MPWREP	250°C			
SN74AHC125MDREP	235°C	250°C		
SN74AHC125MPWREP	250°C			
SN74AHC14MDREP	220°C			
SN74AHC244MDWREP	235°C	250°C		
SN74AHC244MPWREP	250°C			
SN74AHC245MDWREP	235°C	250°C		
SN74AHC245MPWREP	250°C			
SN74AHC32MDREP	235°C	250°C		
SN74AHC32MPWREP	250°C			
SN74AHC74MDREP	235°C	250°C		
SN74AHC74MPWREP	250°C			
SN74AHCT00MDREP	235°C	250°C		
SN74AHCT00MPWREP	250°C			
SN74AHCT08MDREP	235°C	250°C		
SN74AHCT08MPWREP	250°C			
SN74AHCT138MDREP	235°C	250°C		
SN74AHCT138MPWREP	250°C			
SN74AHCT14MDREP	235°C	250°C		
SN74AHCT14MPWREP	250°C			
SN74AHCT244MDWREP	235°C	250°C		
SN74AHCT32MDREP	235°C	250°C		
SN74AHCT74MDREP	235°C	250°C		
SN74AHCT74MPWREP	250°C			
SN74HC02MDREP	235°C	250°C		
SN74HC244MDWREP	220°C			
SN74LV08ATPWREP	250°C			
SN74LV123ATPWREP	250°C			
SN74LV14ATPWREP	250°C			
SN74LV374ATPWREP	250°C			
SN74LV4051ATPWREP	250°C			
SN74LV4052ATPWREP	250°C			
SN74LV4053ATPWREP	250°C			
Device	Level 1	Level 2	Level 3	Level 4

DSP Enhanced Plastic Moisture Sensitivity Level				
Device	Level 1	Level 2	Level 3	Level 4
SM320C32PCMM50EP				220°C
SM320C32PCMM60EP				220°C
SM320C50PQM66EP				220°C
SM320LC31PQM40EP				220°C
SM320LF2407APGEMEP	220°C			
SM320VC33PGEA120EP	220°C			

Device	Level 1	Level 2	Level 3	Level 4
TPS77633QPWPREP	220°C			
TPS79101DBVREP	220°C			
TPS79118DBVREP	220°C			
TPS79133DBVREP	220°C			
TPS79147DBVREP	220°C			
TPS79301DBVREP	220°C			
TPS79318DBVREP	220°C			
TPS79325DBVREP	220°C			
TPS79333DBVREP	220°C			
TPS793475DBVREP	220°C			
TSB12LV01BIPZTEP			235°C	
TSB12LV26TPZEP				220°C
TSB12LV26TPZTEP			235°C	
TSB12LV32TPZEP		220°C		
TSB12LV32TPZTEP		220°C		
TSB41AB3IPFPEP			220°C	
TSB41BA3TPFPEP			220°C	
UC1842AMDREP	220°C			
UC1843AMDREP	220°C			
UC1844AMDREP	220°C			
UC1845AMDREP	220°C			
UC2832TDWEP		220°C		
UC2832TDWREP		220°C		
UCC2800QDREP	220°C			
UCC2801QDREP	220°C			
UCC2802QDREP	220°C			
UCC2803QDREP	220°C			
UCC2804QDREP	220°C			
UCC2805QDREP	220°C			
Device	Level 1	Level 2	Level 3	Level 4

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